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Regional Forum on Climate Change (RFCC)
LOW CARBON AND CLIMATE RESILIENT SOCIETIES: BRIDGING SCIENCE, PRACTICE AND POLICY
01-03 July, 2015

Asian Institute of Technology Conference Center, Thailand
Tel/Fax: +66-2-524-5790/6425

มหาวิทยาลัยเทคโนโลยีราชมงคลศรีวิชัย
เลขที่: ๒๒๖
วันที่: ๒๗ เม.ย. ๒๕๕๘
เวลา: ๙ น. ถึง ๕ น.

rfcc2015@ait.asia
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1 April 2015

President

Rajamangala University of Technology Srivijaya
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กองวิเทศสัมพันธ์และการประกันคุณภาพ
มหาวิทยาลัยเทคโนโลยีราชมงคลศรีวิชัย
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เวลา: ๑๑-๓๐ น.

Dear Sir,

Warm greetings from the Asian Institute of Technology (AIT).

I'd like to bring to your attention an upcoming high profile event "**Regional Forum on Climate Change (RFCC) - Low Carbon and Climate Resilient Societies: Bridging Science, Practice, and Policy**", which will be held from 1st – 3rd July, 2015 on the premises of the Asian Institute of Technology, Thailand. The event is jointly organized by the AIT; French Ministry of Foreign Affairs and International Development; ASEAN secretariat, and the European Union. Please visit the conference website www.rfcc2015.ait.asia for more details. Also attached with this mail is the **brochure** for the event.

The RFCC will discuss a wide range of topics related to climate change, and thus welcomes participation from all sectors and streams. May I request you to apprise the relevant researchers in your esteemed institution to avail of this opportunity to participate in this Forum through submission of extended abstracts? The themes and other details for submission of extended abstracts can be found in the link <http://www.rfcc2015.ait.asia/Abstracts>. **Abstract submission deadline has been extended to 30th April 2015. Excellent abstracts will be invited to develop full papers, after the forum, for a special issue journal publication.**

It is my pleasure to announce that **varying levels of financial support is available for excellent submissions from developing countries, on a first come first served basis. Special discount is also available for students.**

I count on your support in disseminating this information among your colleagues and staff. Please feel free to contact the Forum secretariat at rfcc2015@ait.asia for any queries.

Sincerely yours,

Prof. Mukand S. Babel
Chair, Organizing Committee RFCC (rfcc2015@ait.asia)
Asian Institute of Technology